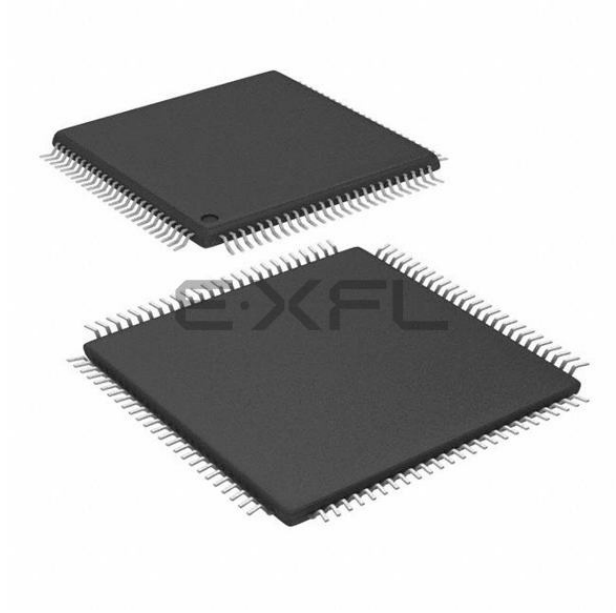
Microchip Technology - PIC32MZ0512EFK100-E/PT Datasheet



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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	MIPS32® M-Class
Core Size	32-Bit Single-Core
Speed	180MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, PMP, SPI, SQI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I²S, POR, PWM, WDT
Number of I/O	78
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.1V ~ 3.6V
Data Converters	A/D 40x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mz0512efk100-e-pt

TABLE 1-14: USB PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	64-pin QFN/ TQFP	100-pin TQFP	124-pin VTLA	144-pin TQFP/ LQFP			
VBUS	33	51	A35	73	I	Analog	USB bus power monitor
VUSB3V3	34	52	A36	74	P	—	USB internal transceiver supply. If the USB module is *not* used, this pin must be connected to VSS. When connected, the shared pin functions on USBID will *not* be available.
D+	37	55	B30	77	I/O	Analog	USB D+
D-	36	54	A37	76	I/O	Analog	USB D-
USBID	38	56	A38	78	I	ST	USB OTG ID detect

Legend: CMOS = CMOS-compatible input or output; Analog = Analog input; P = Power
ST = Schmitt Trigger input with CMOS levels; O = Output; I = Input
TTL = Transistor-transistor Logic input buffer; PPS = Peripheral Pin Select

TABLE 1-15: CAN1 AND CAN2 PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	64-pin QFN/ TQFP	100-pin TQFP	124-pin VTLA	144-pin TQFP/ LQFP			
C1TX	PPS	PPS	PPS	PPS	O	—	CAN1 Bus Transmit Pin
C1RX	PPS	PPS	PPS	PPS	I	ST	CAN1 Bus Receive Pin
C2TX	PPS	PPS	PPS	PPS	O	—	CAN2 Bus Transmit Pin
C2RX	PPS	PPS	PPS	PPS	I	ST	CAN2 Bus Receive Pin

Legend: CMOS = CMOS-compatible input or output; Analog = Analog input; P = Power
ST = Schmitt Trigger input with CMOS levels; O = Output; I = Input
TTL = Transistor-transistor Logic input buffer; PPS = Peripheral Pin Select

The MIPS architecture defines that the result of a multiply or divide operation be placed in one of four pairs of HI and LO registers. Using the Move-From-HI (MFHI) and Move-From-LO (MFLO) instructions, these values can be transferred to the General Purpose Register file.

In addition to the HI/LO targeted operations, the MIPS32 architecture also defines a multiply instruction, MUL, which places the least significant results in the primary register file instead of the HI/LO register pair. By avoiding the explicit MFLO instruction required when using the LO register, and by supporting multiple destination registers, the throughput of multiply-intensive operations is increased.

Two other instructions, Multiply-Add (MADD) and Multiply-Subtract (MSUB), are used to perform the multiply-accumulate and multiply-subtract operations. The MADD instruction multiplies two numbers and then adds the product to the current contents of the HI and LO registers. Similarly, the MSUB instruction multiplies two operands and then subtracts the product from the HI and LO registers. The MADD and MSUB operations are commonly used in DSP algorithms.

The MDU also implements various shift instructions operating on the HI/LO register and multiply instructions as defined in the DSP ASE. The MDU supports all of the data types required for this purpose and includes three extra HI/LO registers as defined by the ASE.

Table 3-2 lists the latencies and repeat rates for the DSP multiply and dot-product operations. The approximate latencies and repeat rates are listed in terms of pipeline clocks.

TABLE 3-2: DSP-RELATED LATENCIES AND REPEAT RATES

Op code	Latency	Repeat Rate
Multiply and dot-product without saturation after accumulation	5	1
Multiply and dot-product with saturation after accumulation	5	1
Multiply without accumulation	5	1

3.1.3 SYSTEM CONTROL COPROCESSOR (CP0)

In the MIPS architecture, CP0 is responsible for the virtual-to-physical address translation and cache protocols, the exception control system, the processor's diagnostics capability, the operating modes (Kernel, User and Debug) and whether interrupts are enabled or disabled. Configuration information, such as cache size and set associativity, and the presence of options like microMIPS is also available by accessing the CP0 registers, listed in Table 3-3.

TABLE 3-3: COPROCESSOR 0 REGISTERS

Register Number	Register Name	Function
0	Index	Index into the TLB array (MPU only).
1	Random	Randomly generated index into the TLB array (MPU only).
2	EntryLo0	Low-order portion of the TLB entry for even-numbered virtual pages (MPU only).
3	EntryLo1	Low-order portion of the TLB entry for odd-numbered virtual pages (MPU only).
4	Context/ UserLocal	Pointer to the page table entry in memory (MPU only). User information that can be written by privileged software and read via the RDHWR instruction.
5	PageMask/ PageGrain	PageMask controls the variable page sizes in TLB entries. PageGrain enables support of 1 KB pages in the TLB (MPU only).
6	Wired	Controls the number of fixed (i.e., wired) TLB entries (MPU only).
7	HWREna	Enables access via the RDHWR instruction to selected hardware registers in Non-privileged mode.
8	BadVAddr	Reports the address for the most recent address-related exception.
	BadInstr	Reports the instruction that caused the most recent exception.
	BadInstrP	Reports the branch instruction if a delay slot caused the most recent exception.
9	Count	Processor cycle count.
10	EntryHi	High-order portion of the TLB entry (MPU only).
11	Compare	Core timer interrupt control.

REGISTER 4-10: SBTxWRy: SYSTEM BUS TARGET 'x' REGION 'y' WRITE PERMISSIONS REGISTER ('x' = 0-13; 'y' = 0-8)

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	U-0	U-0	U-0	U-0	R/W-0	R/W-1	R/W-1	R/W-1
	—	—	—	—	GROUP3	GROUP2	GROUP1	GROUP0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared

bit 31-4 **Unimplemented:** Read as '0'

bit 3 **Group3:** Group 3 Write Permissions bits
- 1 = Privilege Group 3 has write permission
- 0 = Privilege Group 3 does not have write permission

bit 2 **Group2:** Group 2 Write Permissions bits
- 1 = Privilege Group 2 has write permission
- 0 = Privilege Group 2 does not have write permission

bit 1 **Group1:** Group 1 Write Permissions bits
- 1 = Privilege Group 1 has write permission
- 0 = Privilege Group 1 does not have write permission

bit 0 **Group0:** Group 0 Write Permissions bits
- 1 = Privilege Group 0 has write permission
- 0 = Privilege Group 0 does not have write permission

Note 1: Refer to Table 4-6 for the list of available targets and their descriptions.

2: For some target regions, certain bits in this register are read-only with preset values. See Table 4-6 for more information.

TABLE 7-3: INTERRUPT REGISTER MAP (CONTINUED)

Virtual Address (BF81_#)	Register Name(1)	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
07E0	OFF168	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
07E4	OFF169	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
07E8	OFF170	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
07EC	OFF171	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
07F0	OFF172	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
07F4	OFF173	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
07F8	OFF174	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
07FC	OFF175	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0800	OFF176(2)	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0804	OFF177(2)	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0808	OFF178(2)	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
080C	OFF179	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0810	OFF180	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0814	OFF181	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0818	OFF182	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table with the exception of the OFFx registers, have corresponding CLR, SET, and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.3 "CLR, SET, and INV Registers"** for more information.
2: This bit or register is not available on 64-pin devices.
3: This bit or register is not available on devices without a CAN module.
4: This bit or register is not available on 100-pin devices.
5: Bits 31 and 30 are not available on 64-pin and 100-pin devices; bits 29 through 14 are not available on 64-pin devices.
6: Bits 31, 30, 29, and bits 5 through 0 are not available on 64-pin and 100-pin devices; bit 31 is not available on 124-pin devices; bit 22 is not available on 64-pin devices.
7: This bit or register is not available on devices without a Crypto module.
8: This bit or register is not available on 124-pin devices.

REGISTER 7-1: INTCON: INTERRUPT CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	NMIKEY<7:0>							
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
	—	—	—	MVEC	—	TPC<2:0>		
7:0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	—	—	INT4EP	INT3EP	INT2EP	INT1EP	INT0EP

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-24 **NMIKEY<7:0>:** Non-Maskable Interrupt Key bits
When the correct key (0x4E) is written, a software NMI will be generated. The status is indicated by the GNMI bit (RNMICON<19>).

bit 23-13 **Unimplemented:** Read as '0'

bit 12 **MVEC:** Multi Vector Configuration bit
1 = Interrupt controller configured for multi vectored mode
0 = Interrupt controller configured for single vectored mode

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **TPC<2:0>:** Interrupt Proximity Timer Control bits
111 = Interrupts of group priority 7 or lower start the Interrupt Proximity timer
110 = Interrupts of group priority 6 or lower start the Interrupt Proximity timer
101 = Interrupts of group priority 5 or lower start the Interrupt Proximity timer
100 = Interrupts of group priority 4 or lower start the Interrupt Proximity timer
011 = Interrupts of group priority 3 or lower start the Interrupt Proximity timer
010 = Interrupts of group priority 2 or lower start the Interrupt Proximity timer
001 = Interrupts of group priority 1 start the Interrupt Proximity timer
000 = Disables Interrupt Proximity timer

bit 7-5 **Unimplemented:** Read as '0'

bit 4 **INT4EP:** External Interrupt 4 Edge Polarity Control bit
1 = Rising edge
0 = Falling edge

bit 3 **INT3EP:** External Interrupt 3 Edge Polarity Control bit
1 = Rising edge
0 = Falling edge

bit 2 **INT2EP:** External Interrupt 2 Edge Polarity Control bit
1 = Rising edge
0 = Falling edge

bit 1 **INT1EP:** External Interrupt 1 Edge Polarity Control bit
1 = Rising edge
0 = Falling edge

bit 0 **INT0EP:** External Interrupt 0 Edge Polarity Control bit
1 = Rising edge
0 = Falling edge

REGISTER 11-18: USBExTXA: USB ENDPOINT 'x' TRANSMIT ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	TXHUBPRT<6:0>						
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	MULTTRAN	TXHUBADD<6:0>						
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	TXFADDR<6:0>						

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31 **Unimplemented:** Read as '0'

bit 30-24 **TXHUBPRT<6:0>:** TX Hub Port bits (*Host mode*)

When a Low-Speed or Full-Speed device is connected to this endpoint through a Hi-Speed USB 2.0 hub, this field records the port number of that USB 2.0 hub.

bit 23 **MULTTRAN:** TX Hub Multiple Translators bit (*Host mode*)
1 = The USB 2.0 hub has multiple transaction translators
0 = The USB 2.0 hub has a single transaction translator

bit 22-16 **TXHUBADD<6:0>:** TX Hub Address bits (*Host mode*)

When a Low-Speed or Full-Speed device is connected to this endpoint through a Hi-Speed USB 2.0 hub, these bits record the address of the USB 2.0 hub.

bit 15-7 **Unimplemented:** Read as '0'

bit 6-0 **TXFADDR<6:0>:** TX Functional Address bits (*Host mode*)

Specifies the address for the target function that is be accessed through the associated endpoint. It needs to be defined for each TX endpoint that is used.

REGISTER 20-20: SQI1BDRXDSTAT: SQI BUFFER DESCRIPTOR DMA RECEIVE STATUS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	R-x	R-x	R-x	R-x	U-0
	—	—	—	RXSTATE<3:0>				—
23:16	U-0	U-0	U-0	R-x	R-x	R-x	R-x	R-x
	—	—	—	RXBUFCNT<4:0>				
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	R-x	R-x	R-x	R-x	R-x	R-x	R-x	R-x
	RXCURBUFLEN<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-29 **Unimplemented:** Read as '0'

bit 28-25 **RXSTATE<3:0>:** Current DMA Receive State Status bits
These bits provide information on the current DMA receive states.

bit 24-21 **Unimplemented:** Read as '0'

bit 20-16 **RXBUFCNT<4:0>:** DMA Buffer Byte Count Status bits
These bits provide information on the internal FIFO space.

bit 15-8 **Unimplemented:** Read as '0'

bit 7-0 **RXCURBUFLEN<7:0>:** Current DMA Receive Buffer Length Status bits
These bits provide the length of the current DMA receive buffer.

REGISTER 20-21: SQI1THR: SQI THRESHOLD CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	—	—	THRES<4:0>				

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-5 **Unimplemented:** Read as '0'

bit 4-0 **THRES<4:0>:** SQI Control Threshold Value bits
The SQI control threshold interrupt is asserted when the amount of space indicated by THRES<4:0> is available in the SQI control buffer.

REGISTER 21-1: I2CxCON: I²C CONTROL REGISTER (CONTINUED)

bit 12 **SCLREL:** SCLx Release Control bit (when operating as I²C slave)
1 = Release SCLx clock
0 = Hold SCLx clock low (clock stretch)
If STREN = 1:
Bit is R/W (i.e., software can write '0' to initiate stretch and write '1' to release clock). Hardware clear at beginning of slave transmission. Hardware clear at end of slave reception.
If STREN = 0:
Bit is R/S (i.e., software can only write '1' to release clock). Hardware clear at beginning of slave transmission.

bit 11 **STRICT:** Strict I²C Reserved Address Rule Enable bit
1 = Strict reserved addressing is enforced. Device does not respond to reserved address space or generate addresses in reserved address space.
0 = Strict I²C Reserved Address Rule is not enabled

bit 10 **A10M:** 10-bit Slave Address bit
1 = I2CxADD is a 10-bit slave address
0 = I2CxADD is a 7-bit slave address

bit 9 **DISSLW:** Disable Slew Rate Control bit
1 = Slew rate control is disabled
0 = Slew rate control is enabled

bit 8 **SMEN:** SMBus Input Levels bit
1 = Enable I/O pin thresholds compliant with SMBus specification
0 = Disable SMBus input thresholds

bit 7 **GCEN:** General Call Enable bit (when operating as I²C slave)
1 = Enable interrupt when a general call address is received in the I2CxRSR (module is enabled for reception)
0 = General call address is disabled

bit 6 **STREN:** SCLx Clock Stretch Enable bit (when operating as I²C slave)
Used in conjunction with SCLREL bit.
1 = Enable software or receive clock stretching
0 = Disable software or receive clock stretching

bit 5 **ACKDT:** Acknowledge Data bit (when operating as I²C master, applicable during master receive)
Value that is transmitted when the software initiates an Acknowledge sequence.
1 = Send NACK during Acknowledge
0 = Send ACK during Acknowledge

bit 4 **ACKEN:** Acknowledge Sequence Enable bit
(when operating as I²C master, applicable during master receive)
1 = Initiate Acknowledge sequence on SDAx and SCLx pins and transmit ACKDT data bit. Hardware clear at end of master Acknowledge sequence.
0 = Acknowledge sequence not in progress

bit 3 **RCEN:** Receive Enable bit (when operating as I²C master)
1 = Enables Receive mode for I²C. Hardware clear at end of eighth bit of master receive data byte.
0 = Receive sequence not in progress

bit 2 **PEN:** Stop Condition Enable bit (when operating as I²C master)
1 = Initiate Stop condition on SDAx and SCLx pins. Hardware clear at end of master Stop sequence.
0 = Stop condition not in progress

bit 1 **RSEN:** Repeated Start Condition Enable bit (when operating as I²C master)
1 = Initiate Repeated Start condition on SDAx and SCLx pins. Hardware clear at end of master Repeated Start sequence.
0 = Repeated Start condition not in progress

bit 0 **SEN:** Start Condition Enable bit (when operating as I²C master)
1 = Initiate Start condition on SDAx and SCLx pins. Hardware clear at end of master Start sequence.
0 = Start condition not in progress

REGISTER 28-4: ADCTRGMODE: ADC TRIGGERING MODE FOR DEDICATED ADC REGISTER

bit 9 **STRGEN1:** ADC1 Presynchronized Triggers bit
1 = ADC1 uses presynchronized triggers
0 = ADC1 does not use presynchronized triggers

bit 8 **STRGEN0:** ADC0 Presynchronized Triggers bit
1 = ADC0 uses presynchronized triggers
0 = ADC0 does not use presynchronized triggers

bit 7-5 **Unimplemented:** Read as '0'

bit 4 **SSAMPEN4:** ADC4 Synchronous Sampling bit
1 = ADC4 uses synchronous sampling for the first sample after being idle or disabled
0 = ADC4 does not use synchronous sampling

bit 3 **SSAMPEN3:** ADC3 Synchronous Sampling bit
1 = ADC3 uses synchronous sampling for the first sample after being idle or disabled
0 = ADC3 does not use synchronous sampling

bit 2 **SSAMPEN2:** ADC2Synchronous Sampling bit
1 = ADC2 uses synchronous sampling for the first sample after being idle or disabled
0 = ADC2 does not use synchronous sampling

bit 1 **SSAMPEN1:** ADC1 Synchronous Sampling bit
1 = ADC1 uses synchronous sampling for the first sample after being idle or disabled
0 = ADC1 does not use synchronous sampling

bit 0 **SSAMPEN0:** ADC0 Synchronous Sampling bit
1 = ADC0 uses synchronous sampling for the first sample after being idle or disabled
0 = ADC0 does not use synchronous sampling

REGISTER 29-2: CiCFG: CAN BAUD RATE CONFIGURATION REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
	—	WAKFIL	—	—	—	SEG2PH<2:0>(1,4)		
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	SEG2PHTS(1)	SAM(2)	SEG1PH<2:0>			PRSEG<2:0>		
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	SJW<1:0>(3)		BRP<5:0>					

Legend:	HC = Hardware Clear	S = Settable bit	
R = Readable bit	W = Writable bit	P = Programmable bit	r = Reserved bit
U = Unimplemented bit	-n = Bit Value at POR: (‘0’, ‘1’, x = Unknown)		

bit 31-23 **Unimplemented:** Read as ‘0’

bit 22 **WAKFIL:** CAN Bus Line Filter Enable bit
1 = Use CAN bus line filter for wake-up
0 = CAN bus line filter is not used for wake-up

bit 21-19 **Unimplemented:** Read as ‘0’

bit 18-16 **SEG2PH<2:0>:** Phase Buffer Segment 2 bits(1,4)
111 = Length is 8 x TQ
•
•
•
000 = Length is 1 x TQ

bit 15 **SEG2PHTS:** Phase Segment 2 Time Select bit(1)
1 = Freely programmable
0 = Maximum of SEG1PH or Information Processing Time, whichever is greater

bit 14 **SAM:** Sample of the CAN Bus Line bit(2)
1 = Bus line is sampled three times at the sample point
0 = Bus line is sampled once at the sample point

bit 13-11 **SEG1PH<2:0>:** Phase Buffer Segment 1 bits(4)
111 = Length is 8 x TQ
•
•
•
000 = Length is 1 x TQ

Note 1: SEG2PH ≤ SEG1PH. If SEG2PHTS is clear, SEG2PH will be set automatically.
2: 3 Time bit sampling is not allowed for BRP < 2.
3: SJW ≤ SEG2PH.
4: The Time Quanta per bit must be greater than 7 (that is, TQBIT > 7).

Note: This register can only be modified when the CAN module is in Configuration mode (OPMOD<2:0> (CiCON<23:21>) = 100).

REGISTER 29-21: CiFIFOINTn: CAN FIFO INTERRUPT REGISTER 'n' ('n' = 0-31) (CONTINUED)

bit 9 **TXHALFIF:** FIFO Transmit FIFO Half Empty Interrupt Flag bit(1)

TXEN = 1: (FIFO configured as a Transmit Buffer)
1 = FIFO is ≤ half full
0 = FIFO is > half full

TXEN = 0: (FIFO configured as a Receive Buffer)
Unused, reads '0'

bit 8 **TXEMPTYIF:** Transmit FIFO Empty Interrupt Flag bit(1)

TXEN = 1: (FIFO configured as a Transmit Buffer)
1 = FIFO is empty
0 = FIFO is not empty, at least 1 message queued to be transmitted

TXEN = 0: (FIFO configured as a Receive Buffer)
Unused, reads '0'

bit 7-4 **Unimplemented:** Read as '0'

bit 3 **RXOVFLIF:** Receive FIFO Overflow Interrupt Flag bit

TXEN = 1: (FIFO configured as a Transmit Buffer)
Unused, reads '0'

TXEN = 0: (FIFO configured as a Receive Buffer)
1 = Overflow event has occurred
0 = No overflow event occurred

bit 2 **RXFULLIF:** Receive FIFO Full Interrupt Flag bit(1)

TXEN = 1: (FIFO configured as a Transmit Buffer)
Unused, reads '0'

TXEN = 0: (FIFO configured as a Receive Buffer)
1 = FIFO is full
0 = FIFO is not full

bit 1 **RXHALFIF:** Receive FIFO Half Full Interrupt Flag bit(1)

TXEN = 1: (FIFO configured as a Transmit Buffer)
Unused, reads '0'

TXEN = 0: (FIFO configured as a Receive Buffer)
1 = FIFO is ≥ half full
0 = FIFO is < half full

bit 0 **RXNEMPTYIF:** Receive Buffer Not Empty Interrupt Flag bit(1)

TXEN = 1: (FIFO configured as a Transmit Buffer)
Unused, reads '0'

TXEN = 0: (FIFO configured as a Receive Buffer)
1 = FIFO is not empty, has at least 1 message
0 = FIFO is empty

Note 1: This bit is read-only and reflects the status of the FIFO.

TABLE 34-5: DEVICE ADC CALIBRATION SUMMARY

Virtual Address (BFC5_#)	Register Name	Bit Range	Bits															All Resets(1)
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
4000	DEVADC0	31:16	ADC Calibration Data <31:16>																xxxx
		15:0	ADC Calibration Data <15:0>																xxxx
4004	DEVADC1	31:16	ADC Calibration Data <31:16>																xxxx
		15:0	ADC Calibration Data <15:0>																xxxx
4008	DEVADC2	31:16	ADC Calibration Data <31:16>																xxxx
		15:0	ADC Calibration Data <15:0>																xxxx
400C	DEVADC3	31:16	ADC Calibration Data <31:16>																xxxx
		15:0	ADC Calibration Data <15:0>																xxxx
4010	DEVADC4	31:16	ADC Calibration Data <31:16>																xxxx
		15:0	ADC Calibration Data <15:0>																xxxx
401C	DEVADC7	31:16	ADC Calibration Data <31:16>																xxxx
		15:0	ADC Calibration Data <15:0>																xxxx

Legend: x = unknown value on Reset.
Note 1: Reset values are dependent on the device variant.

REGISTER 34-5: DEVCFG2/ADEVCFG2: DEVICE CONFIGURATION WORD 2 (CONTINUED)

bit 3 **Reserved:** Write as '1'

bit 2-0 **FPLLIDIV<2:0>:** PLL Input Divider bits

111 = Divide by 8
110 = Divide by 7
101 = Divide by 6
100 = Divide by 5
011 = Divide by 4
010 = Divide by 3
001 = Divide by 2
000 = Divide by 1

REGISTER 34-9: CFGEBIC: EXTERNAL BUS INTERFACE CONTROL PIN CONFIGURATION REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0
	EBI RDYINV3	EBI RDYINV2	EBI RDYIN1	—	EBI RDYEN3	EBI RDYEN2	EBI RDYEN1	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
	—	—	—	—	—	—	EBIRDYLVL	EBIRPEN
15:8	U-0	U-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0
	—	—	EBIWEEN	EBIOEEN	—	—	EBIBSEN1	EBIBSEN0
7:0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0
	EBICSEN3	EBICSEN2	EBICSEN1	EBICSEN0	—	—	EBIDEN1	EBIDEN0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31 **EBIRDYINV3:** EBIRDY3 Inversion Control bit
1 = Invert EBIRDY3 pin before use
0 = Do not invert EBIRDY3 pin before use

bit 30 **EBIRDYINV2:** EBIRDY2 Inversion Control bit
1 = Invert EBIRDY2 pin before use
0 = Do not invert EBIRDY2 pin before use

bit 29 **EBIRDYINV1:** EBIRDY1 Inversion Control bit
1 = Invert EBIRDY1 pin before use
0 = Do not invert EBIRDY1 pin before use

bit 28 **Unimplemented:** Read as '0'

bit 27 **EBIRDYEN3:** EBIRDY3 Pin Enable bit
1 = EBIRDY3 pin is enabled for use by the EBI module
0 = EBIRDY3 pin is available for general use

bit 26 **EBIRDYEN2:** EBIRDY2 Pin Enable bit
1 = EBIRDY2 pin is enabled for use by the EBI module
0 = EBIRDY2 pin is available for general use

bit 25 **EBIRDYEN1:** EBIRDY1 Pin Enable bit
1 = EBIRDY1 pin is enabled for use by the EBI module
0 = EBIRDY1 pin is available for general use

bit 24-18 **Unimplemented:** Read as '0'

bit 17 **EBIRDYLVL:** EBIRDYx Pin Sensitivity Control bit
1 = Use level detect for EBIRDYx pins
0 = Use edge detect for EBIRDYx pins

bit 16 **EBIRPEN:** $\overline{\text{EBIRP}}$ Pin Sensitivity Control bit
1 = $\overline{\text{EBIRP}}$ pin is enabled for use by the EBI module
0 = $\overline{\text{EBIRP}}$ pin is available for general use

bit 15-14 **Unimplemented:** Read as '0'

bit 13 **EBIWEEN:** $\overline{\text{EBIWE}}$ Pin Enable bit
1 = $\overline{\text{EBIWE}}$ pin is enabled for use by the EBI module
0 = $\overline{\text{EBIWE}}$ pin is available for general use

Note: When EBIMD = 1, the bits in this register are ignored and the pins are available for general use.

TABLE 37-11: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS (CONTINUED)

DC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param.	**Sym.**	**Characteristic**	**Min.**	**Typ.**	**Max.**	**Units**	**Conditions(1)**
DO20	VOH	**Output High Voltage** I/O Pins: 4x Source Driver Pins - RA3, RA9, RA10, RA14, RA15 RB0-RB2, RB4, RB6-RB7, RB11, RB13 RC12-RC15 RD0, RD6-RD7, RD11, RD14 RE8, RE9 RF2, RF3, RF8 RG15 RH0, RH1, RH4-RH6, RH8-RH13 RJ0-RJ2, RJ8, RJ9, RJ11	2.4	—	—	V	IOH ≥ -10 mA, VDD = 3.3V
		Output High Voltage I/O Pins: 8x Source Driver Pins - RA0-RA2, RA4, RA5 RB3, RB5, RB8-RB10, RB12, RB14, RB15 RC1-RC4 RD1-RD5, RD9, RD10, RD12, RD13, RD15 RE4-RE7 RF0, RF4, RF5, RF12, RF13 RG0, RG1, RG6-RG9 RH2, RH3, RH7, RH14, RH15 RJ3-RJ7, RJ10, RJ12-RJ15 RK0-RK7	2.4	—	—	V	IOH ≥ -15 mA, VDD = 3.3V
		Output High Voltage I/O Pins: 12x Source Driver Pins - RA6, RA7 RE0-RE3 RF1 RG12-RG14	2.4	—	—	V	IOH ≥ -20 mA, VDD = 3.3V

Note 1: Parameters are characterized, but not tested.

TABLE 37-34: SQI TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param. No.	**Symbol**	**Characteristic(1,3)**	**Min.**	**Typ.(2)**	**Max.**	**Units**	**Conditions**
SQ10	FCLK	Serial Clock Frequency (1/TSQI)	—	66	—	MHz	DMA mode Read, SPI mode 0
			—	33	—	MHz	DMA mode Read, SPI mode 3
			—	100	—	MHz	PIO mode Write
SQ11	TSCKH	Serial Clock High Time	5	—	—	ns	—
SQ12	TSCKL	Serial Clock Low Time	5	—	—	ns	—
SQ13	TSCKR	Serial Clock Rise Time	—	—	—	ns	See parameter DO31
SQ14	TSCKF	Serial Clock Fall Time	—	—	—	ns	See parameter DO32
SQ15	TCSS (TCES)	$\overline{CS}$ Active Setup Time	5	—	—	ns	—
SQ16	TCSH (TCEH)	$\overline{CS}$ Active Hold Time	5	—	—	ns	—
SQ17	TCHS	$\overline{CS}$ Not Active Setup Time	3	—	—	ns	—
SQ18	TCHH	$\overline{CS}$ Not Active Hold Time	3	—	—	ns	—
SQ22	TDIS	Data In Setup Time	6	—	—	ns	—
SQ23	TDIH	Data In Hold Time	3	—	—	ns	—
SQ24	TDOH	Data Out Hold	0	—	—	ns	—
SQ25	TDOV	Data Out Valid	—	—	6	ns	—

Note 1: These parameters are characterized, but not tested in manufacturing.

2: Data in the Typical column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

3: Assumes 10 pF load on all SQIx pins

TABLE 37-38: ADC MODULE SPECIFICATIONS

AC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param. No.	**Symbol**	**Characteristics**	**Min.**	**Typ.**	**Max.**	**Units**	**Conditions**
Device Supply							
AD01	AVDD	Module VDD Supply	Greater of VDD – 0.3 or 2.1	—	Lesser of VDD + 0.3 or 3.6	V	—
AD02	AVSS	Module VSS Supply	VSS	—	VSS + 0.3	V	—
Reference Inputs							
AD05	VREFH	Reference Voltage High	VREFL + 1.8	—	AVDD	V	**(Note 1)**
AD06	VREFL	Reference Voltage Low	AVSS	—	VREFH – 1.8	V	**(Note 1)**
AD07	VREF	Absolute Reference Voltage (VREFH – VREFL)	1.8	—	AVDD	V	**(Note 2)**
AD08	IREF	Current Drain	—	102	—	µA	Per ADCx ('x' = 0-4, 7)
Analog Input							
AD12	VINH-VINL	Full-Scale Input Span	VREFL	—	VREFH	V	—
AD13	VINL	Absolute VINL Input Voltage	AVSS	—	VREFL	V	—
AD14	VINH	Absolute VINH Input Voltage	AVSS	—	VREFH	V	—
ADC Accuracy – Measurements with External VREF+/VREF-							
AD20c	Nr	Resolution	6	—	12	bits	Selectable 6, 8, 10, 12 Resolution Ranges
AD21c	INL	Integral Nonlinearity	—	±3	—	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V
AD22c	DNL	Differential Nonlinearity	—	±1	—	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V
AD23c	GERR	Gain Error	—	±8	—	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V
AD24c	EOFF	Offset Error	—	±2	—	LSb	VINL = AVSS = 0V, AVDD = 3.3V
Dynamic Performance							
AD31b	SINAD	Signal to Noise and Distortion	—	67	—	dB	Single-ended **(Notes 2,3)**
AD34b	ENOB	Effective Number of bits	—	10.5	—	bits	**(Notes 2,3)**

Note 1: These parameters are not characterized or tested in manufacturing.

2: These parameters are characterized, but not tested in manufacturing.

3: Characterized with a 1 kHz sine wave.

4: The ADC module is functional at VBORMIN < VDD < VDDMIN, but with degraded performance. Unless otherwise stated, module functionality is guaranteed, but not characterized.

B.3 CPU

The CPU in PIC32MZ EC devices is the microAptiv™ MPU architecture. The CPU in the PIC32MZ EF devices is the Series 5 Warrior M-Class M5150 MPU architecture. Most PIC32MZ EF M-Class core features are identical to the microAptiv™ core in PIC32MZ EC devices. The main differences are that in PIC32MZ EF devices, a floating-point unit (FPU) is included for improved math performance, and PC Sampling for performance measurement.

B.4 System Bus

The system bus on PIC32MZ EF devices is similar to the system bus on PIC32MZ EC devices. There are two key differences listed in Table B-3.

TABLE B-3: SYSTEM BUS DIFFERENCES

PIC32MZ EC Feature	PIC32MZ EF Feature
Permission Groups during NMI	
On PIC32MZ EC devices, the permission group in which the CPU is part of is lost during NMI handling, and must be manually restored.	On PIC32MZ EF devices, the prior permission group is preserved, and is restored when the CPU returns from the NMI handler.
DMA Access	
The DMA can access the peripheral registers on Peripheral Bus 1.	On PIC32MZ EF devices, the DMA no longer has access to registers on Peripheral Bus 1. Refer to Table 4-4 for details on which peripherals are now excluded.

B.5 Flash Controller

The Flash controller on PIC32MZ EF devices adds the ability both to control boot Flash aliasing, and for locking the current swap settings. Table B-4 lists theses differences.

TABLE B-4: FLASH CONTROLLER DIFFERENCES

PIC32MZ EC Feature	PIC32MZ EF Feature
Boot Flash Aliasing	
On PIC32MZ EC devices, Boot Flash aliasing is done through the DEVSEQ0 register, but no further changes are possible without rebooting the processor.	On PIC32MZ EF devices, the initial Boot Flash aliasing is determined by the DEVSEQ3 register, but the BFSWAP bit (NVMCON<6>) reflects the state of the aliasing, and can be modified to change it during run-time. BFSWAP (NVMCON<6>) 1 = Boot Flash Bank 2 is mapped to the lower boot alias, and Boot Flash bank 1 is mapped to the upper boot alias 0 = Boot Flash Bank 1 is mapped to the lower boot alias, and Boot Flash Bank 2 is mapped to the upper boot alias
PFM and BFM Swap Locking	
On PIC32MZ EC devices, the swapping of PFM is always available.	On PIC32MZ EF devices, a new control, SWAPLOCK<1:0> (NVMCON2<7:6>) allows the locking of PFSWAP and BFSWAP bits, and can restrict any further changes. SWAPLOCK<1:0> (NVMCON2<7:6>) 11 = PFSWAP and BFSWAP are not writable and SWAPLOCK is not writable 10 = PFSWAP and BFSWAP are not writable and SWAPLOCK is writable 01 = PFSWAP and BFSWAP are not writable and SWAPLOCK is writable 00 = PFSWAP and BFSWAP are writable and SWAPLOCK is writable

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